

$V_{RM} = 200\text{ V}$, $I_{F(AV)} = 10\text{ A}$, $t_{rr} = 30\text{ ns}$
Fast Recovery Diode
SPXS-2102S

Description

The SPXS-2102S is a fast recovery diode of 200 V / 10 A. The maximum t_{rr} of 30 ns is realized by optimizing a life-time control. The low thermal resistance package achieves high performance in terms of heat dissipation.

Features

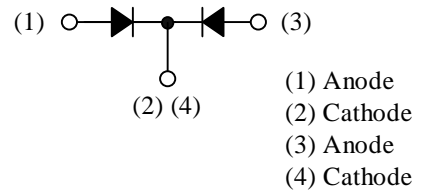
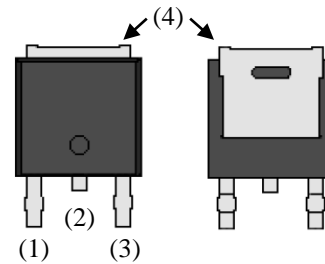
- RoHS Compliant
- V_{RM} ----- 200 V
- $I_{F(AV)}$ ----- 10 A
- V_F ----- 1.25 V
- t_{rr} ----- 30 ns.

Applications

- White Goods
- Audiovisual Equipment
- Lighting Equipment
- Industrial Electronic Equipment
(Communication Equipment and Factory Automation)
- Secondary Side Rectifier Diode
(Flyback Converter, LLC Converter, etc.)
- Freewheel Diode
(Offline Buck and Buck-boost Converter)

Package

TO252-2L



Not to scale

SPXS-2102S

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage	V_{RSM}	200	V	
Repetitive Reverse Voltage	V_{RM}	200	V	
Average Forward Current	$I_{F(AV)}$	10	A	See Figure 1 and Figure 2
Surge Forward Current	I_{FSM}	65	A	Half cycle sine-wave, positive side, 10ms, one shot.
I^2t Limiting Value	I^2t	21	A^2s	$1ms \leq t \leq 10ms$
Junction Temperature	T_J	-40 to 150	$^\circ\text{C}$	
Storage Temperature	T_{STG}	-40 to 150	$^\circ\text{C}$	

Electrical Characteristics

Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	V_F	$T_J = 25\text{ }^\circ\text{C}, I_F = 5.0\text{ A}$	—	—	1.25	V
		$T_J = 100\text{ }^\circ\text{C}, I_F = 5.0\text{ A}$	—	0.83	—	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	—	—	50	μA
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150\text{ }^\circ\text{C}$	—	—	10	mA
Reverse Recovery Time	t_{rr1}	$I_F = I_{RP} = 100\text{ mA}$ 90% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	30	ns
	t_{rr2}	$I_F = 100\text{ mA},$ $I_{RP} = 200\text{ mA},$ 75% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	25	ns
Thermal Resistance ⁽¹⁾	$R_{th(J-L)}$		—	—	5.0	$^\circ\text{C/W}$

⁽¹⁾ $R_{th(J-L)}$ is thermal resistance between junction and lead.

Rating and Characteristic Curves

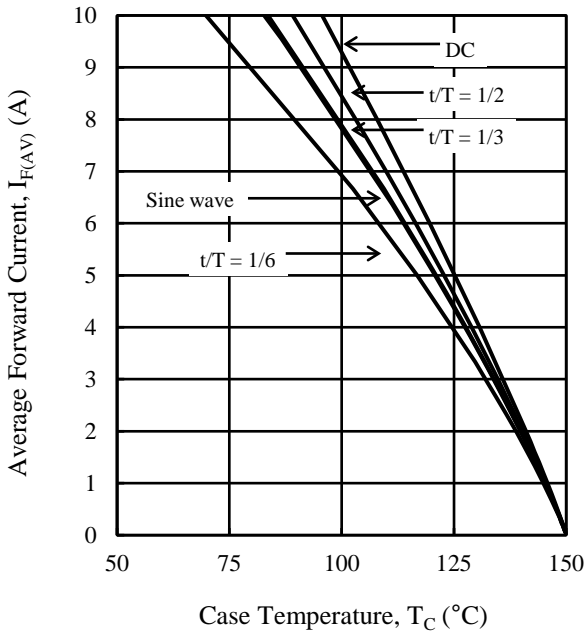


Figure 1. T_C vs. I_F Typical Characteristics ($V_R = 0V$)

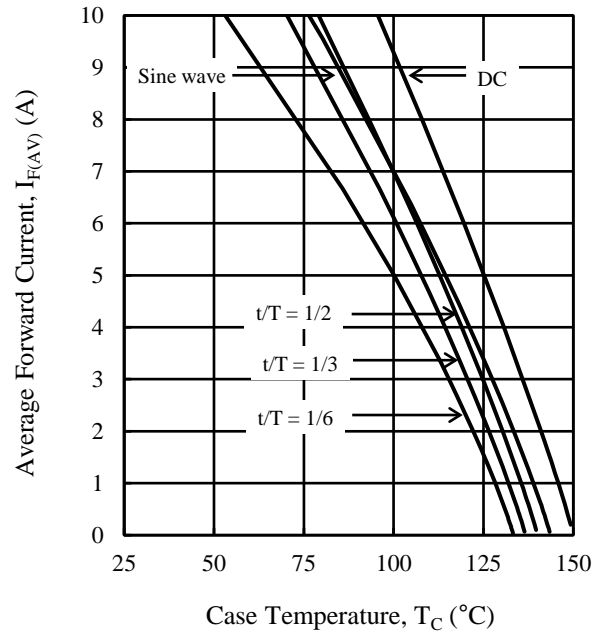


Figure 2. T_C vs. I_F Typical Characteristics ($V_R = 200V$)

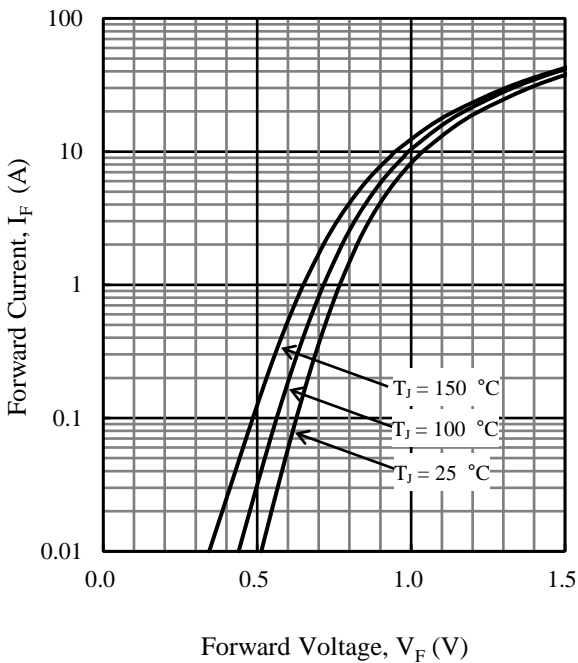


Figure 3. V_F vs. I_F Typical Characteristics

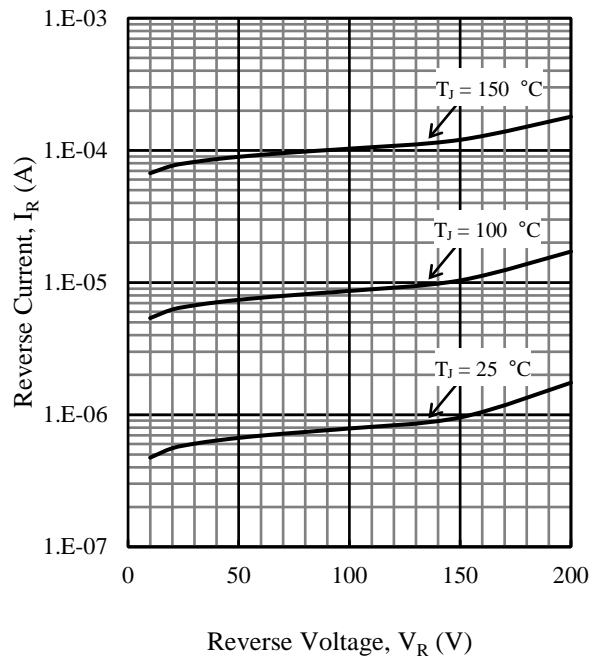
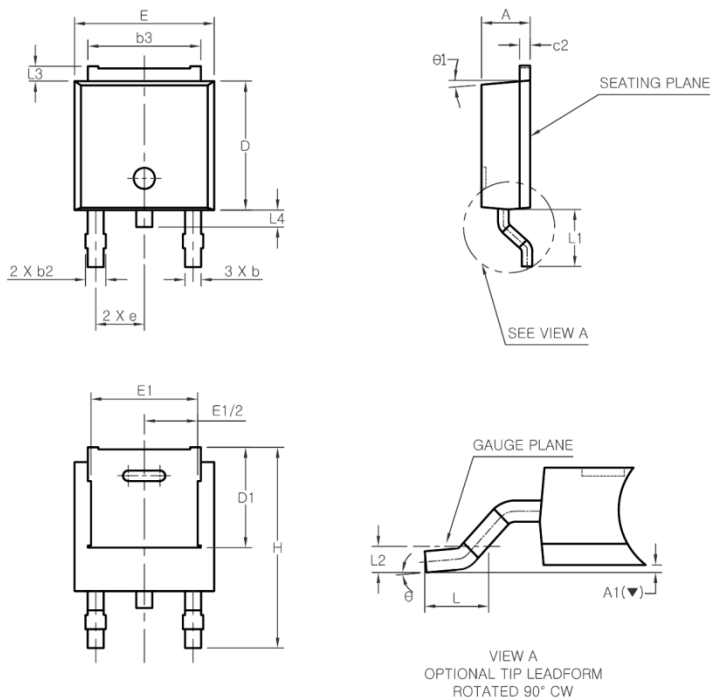


Figure 4. V_R vs. I_R Typical Characteristics

SPXS-2102S

Physical Dimensions

• TO252-2L



SYMBOL	MIN	NOM	MAX
A	2.20	2.30	2.40
A1 (▼)	0.00	-	0.127
b	0.66	0.76	0.86
b2	-	-	0.96
b3	5.04	5.34	5.64
c2	0.40	0.50	0.60
D	5.90	6.10	6.30
D1	(4.75)		
E	6.40	6.60	6.80
E1	(5.04)		
e	2.30 BSC		
H	9.20	9.50	9.80
L	1.27	1.47	1.67
L1	2.50	2.70	2.90
L2	0.508 BSC		
L3	0.50	0.70	0.90
L4	0.60	0.80	1.00
theta	0°	-	10°
theta1	(5°)		

NOTES:

- Dimensions in millimeters
- These dimensions do not include protrusions of the mold.
- The “()” mark is the reference.
- Coplanarity: MAX. 0.10 mm
- The “L4” symbol is a protrusion of the lead frame.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, make sure to minimize the working time, within the following limits:
 Flow: $260 \pm 5 \text{ }^\circ\text{C} / 10 \pm 1 \text{ s}$, 2 times
 Soldering Iron: $380 \pm 5 \text{ }^\circ\text{C} / 3.5 \pm 0.5 \text{ s}$, 1 time

Marking Diagram

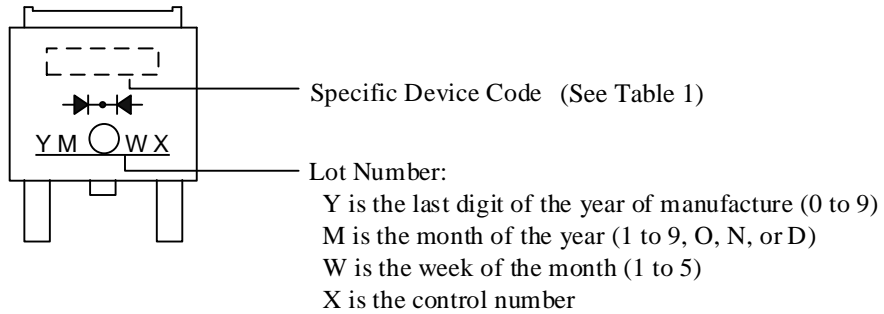


Table 1. Specific Device Code

Specific Device Code	Part Number
XS2102	SPXS-2102S

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DSGN-CEZ-16003